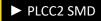
BRIGHTEK (EUROPE) LIMITED ! Brighten Up The World With LED !



PRODUCT DATASHEET



▶ 3528 1.9t Series

 Gold White (PC Amber) 1900K

NOW48S57ZPC-40MA





ATTENTION

OBSERVEPRECAUTI FORHANDLING



FEATURES:

- Package: Top View PLCC2 White SMD Package
- Forward Current: 40mA
- Forward Voltage (typ.): 2.9V
- Luminous Intensity (typ.): 3600mcd@40mA
- Colour: Gold White (PC Amber)
- Colour Temperature (CCT): 1800~2750K
- Viewing angle: 120°
 - Materials:
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+105°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Intensity
 - CIE Chromaticity
- Soldering methods: Reflow Soldering
- Preconditioning: MSL 2a according to J-STD020
- Packing: 8mm tape with max.2000/reel, ø180mm (7")



APPLICATIONS:

- Automotive
- Portable Lighting
- Commercial Lighting
- Indoor Lighting
- Backlight for LCD
- General Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lF	60	mA
Pulse Forward Current @Duty 1/10, 0.1ms	IPF	100	mA
Reverse Voltage	V _R	5	V
Reverse Current @10V	IR	10	μΑ
Junction Temperature	Tj	115	°C
Electrostatic Discharge (HBM)	ESD	6000	V
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	Тѕтб	-40~+105	°C
Soldering Temperature	Tsol	260	°C
Thermal Resistance Junction to Solder Point	\mathbf{R}_{th}	150	°C/W

Electrical & Optical Characteristics (Ta=25°C)

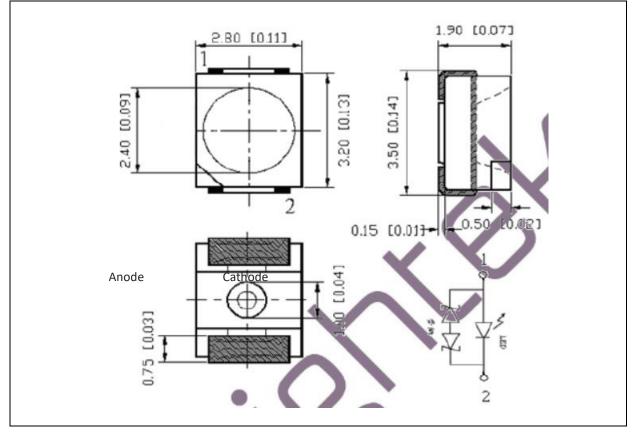
Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Typ. Max.		Onit	Condition	
Forward Voltage	VF	2.6	2.9	3.4	V	I⊧=40mA	
Luminous Intensity	lv	3250	3600		mcd	I⊧=40mA	
Chromaticity	х		0.5702			1 10	
Coordinates	Y		0.4138			I⊧=40mA	
Viewing Angle	20 _{1/2}		120		deg	I _F =40mA	

1. Luminous Intensity (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, Colour Coordinate: ±0.005, Viewing Angle(2 θ 1/2) ±5%, CRI ±5



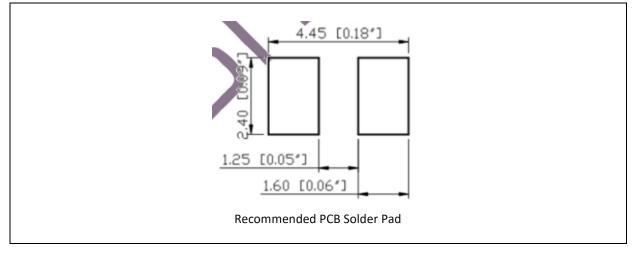
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).

3

2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Code	Min.	Max.	Unit
а	2.6	2.7	
А	2.7	2.8	
В	2.8	2.9	
С	2.9	3.0	V
D	3.0	3.1	v
E	3.1	3.2	
F	3.2	3.3	
G	3.3	3.4	

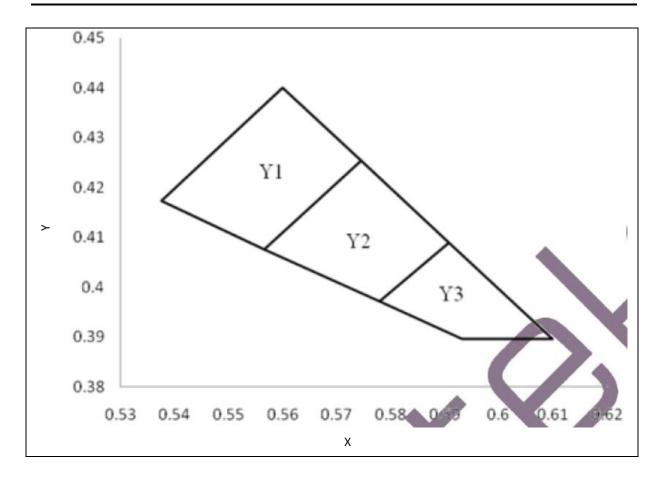
Forward Voltage Classifications (I_F = 40mA):

Luminous Intensity Classifications (I_F = 40mA):

Code	Min.	Max.	Unit
12	3250	3450	
13	3450	3650	mad
14	3650	3850	mcd
15	3850	4050	



CIE CHROMATICITY DIAGRAM:

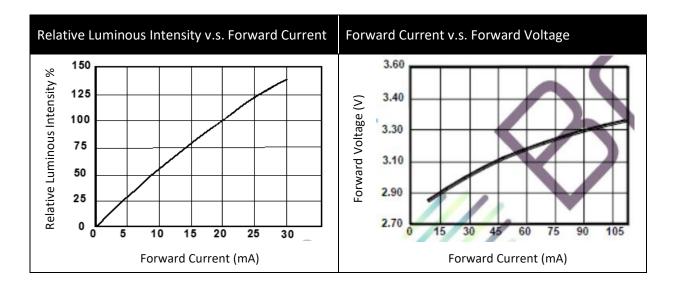


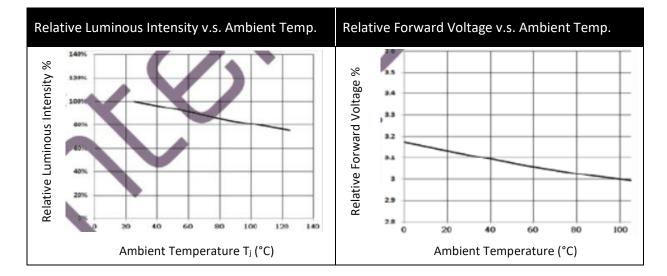
Chromaticity Coordinates Classifications (I_F = 40mA):

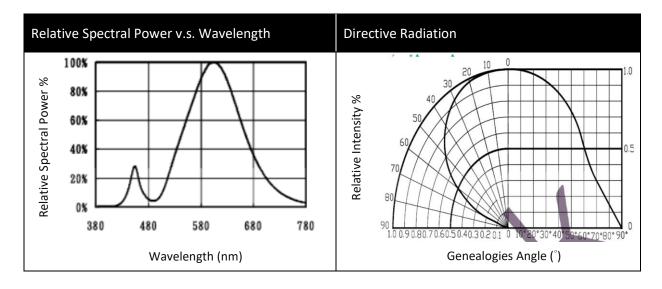
	1	L	2		3		4	
	Х	Y	х	Y	х	Y	Х	Y
Y1	0.5600	0.4400	0.5375	0.4174	0.5566	0.4076	0.5745	0.4253
Y2	0.5745	0.4253	0.5566	0.4076	0.5780	0.3972	0.5908	0.4090
Y3	0.5908	0.4090	0.4780	0.3972	0.5933	0.3896	0.6100	0.3896



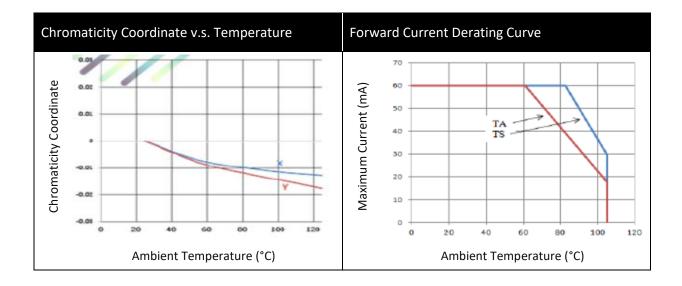
ELECTRO-OPTICAL CHARACTERISTICS:







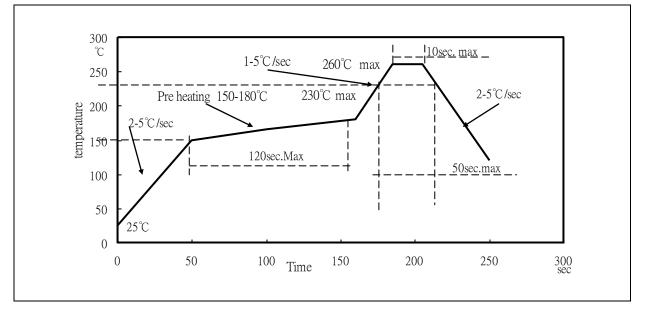






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



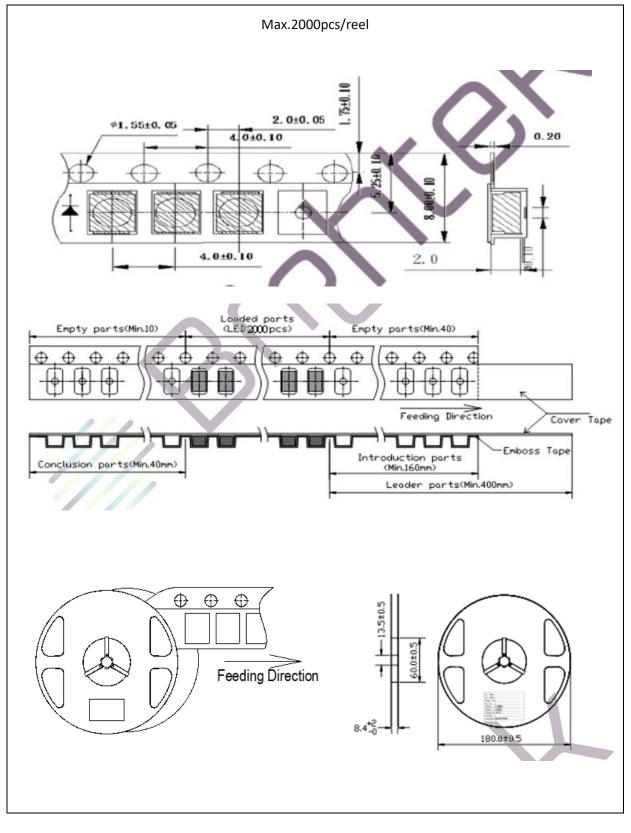
Note:

- 1. Recommended soldering temperature: 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

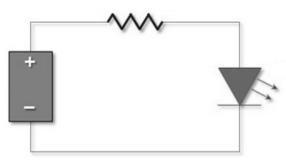
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	16/04/2019	Datasheet set-up.
A1.1	04/06/2022	New datasheet format.